



BT860-SA



BT860-ST

The BT86x series of UART HCI modules leverage the **Cypress CYW20704 A2** chipset to provide exceptionally low power consumption with outstanding range for OEMs needing both **Classic Bluetooth** and **Bluetooth Low Energy** support. The **Bluetooth v5.0** core specification shortens your development time and provides enhanced throughput, security and privacy.

The BT860 modules are ideal when designers need both performance and minimum size. For maximum flexibility in integration, they support a **host UART** interface, **I²S** and **PCM** audio interfaces, **GPIO**, and Cypress' **GCI coexistence** (2-Wire). The modules provide excellent RF performance and identical footprint options for integrated antenna or an external antenna via a trace pin.

These modules present a Bluetooth standard HCI interface with support for **Linux / Android** and **Embedded** Bluetooth software stacks for operating system backed devices. Additionally, we have partnered with **Searan** for support of their ultra small, flexible 'dotstack' platform for embedded Cortex M3 and M4 implementations.

- **Bluetooth v5.0** – Dual Mode – BR / EDR / LE
 - Classic Bluetooth
 - Bluetooth Low Energy (BLE)
- **Compact Footprint** – As small as 8.5x13 mm
- **Class 1 Output** – up to 8 dBm
- UART Host interface
- GPIO, GCI, I²S and PCM
- **Industrial Operating Temp:** -30° to +85°C
- **Bluetooth SIG approved** – Hardware Controller Subsystem
- **International regulatory approvals** – FCC, IC, CE, RCM, Korea, and Japan approvals
- **Broad BT Stack Support** – Linux, Android, Embedded
- **Fully-Featured Development Kit** – Low cost kit for prototyping/debugging/integration testing to speed development time

FEATURES AT A GLANCE



OUTSTANDING RF PERFORMANCE IN A TINY FOOTPRINT

Class 1 +8dBm output power in an 8.5 x 13 mm package means no need to compromise one for the other



EVEN MORE WAYS TO DEVELOP

Wide array of Operating System support, as well as embedded MCU support for Searan's flexible DotStack platform give you even more design choices



BROAD CERTIFICATION AND INTERNATIONAL APPROVALS

Certifications and approvals for FCC (USA), IC (Canada), ETSI (Europe), Giteki (Japan), RCM (AUS/NZ), Bluetooth SIG



PERSONAL SUPPORT FROM DESIGN TO MANUFACTURE

Industry-recognized integration and support organization dedicated to reducing your time to market

APPLICATION AREAS



AIDC Products / Barcode Scanners



Industrial Cable Replacement



IoT Platforms



Medical Devices



Automotive Diagnostics

SHARED SPECIFICATIONS

CATEGORIES	FEATURE	IMPLEMENTATION	
Wireless Specification	Bluetooth®	V5.0 Dual Mode – BR / EDR / LE	
	Frequency	2.402 – 2.480 GHz	
	Max. Transmit Power	Class 1	+8 dBm from antenna +8 dBm from trace pin
		Receive Sensitivity	-94 dBm
		Range	Circa 100 meters
	Data Rates	Up to 3 Mbps (over the air)	
	Host Interface	UART	UART Interface
Operational Modes	HCI	Host Controller Interface over UART	
Coexistence	802.11 (Wi-Fi)	2-wire Cypress Global Coexistence Interface (GCI)	
Supply Voltage	Supply	3.0V – 3.6V (BT860-SA and BT860-ST)	
Power Consumption	Current	Tx Max. < 55 mA	
		Sleep < 120 us	
Antenna Option	Internal	Multilayer Ceramic (BT860-SA)	
	External	SMT Pad (BT860-ST)	
Physical	Dimensions	8.5 x 13 x 2.2 mm (BT860-SA)	
		8.5 x 13 x 1.9 mm (BT860-ST)	
Environmental	Operating	-30° to +85°C	
	Storage	-40° to +85°C	
Miscellaneous	Lead Free	Lead-free and RoHS compliant	
	Warranty	One-Year Warranty	
Approvals	Bluetooth®	Hardware Controller Subsystem	
	FCC/IC/CE/RCM/KC/Giteki	All BT86x series	

ORDERING INFORMATION

BT860-SA	BT v5.0 Dual Mode UART HCI Module (Integrated Antenna)
BT860-ST	BT v5.0 Dual Mode UART HCI Module (SMT Pad for External Antenna)
DVK-BT860-SA	Development Kit for BT860-SA Module
DVK-BT860-ST	Development Kit for BT860-ST Module